### **Power Transistors**

# Panasonic

# 2SD1275, 2SD1275A

### Silicon NPN triple diffusion planar type darlington

#### For power amplification

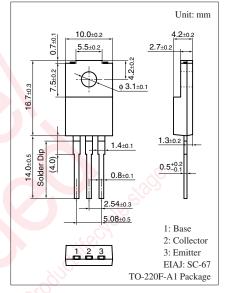
Complementary to 2SB0949 and 2SB0949A

#### Features

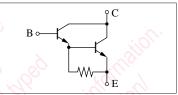
- $\bullet$  High forward current transfer ratio  $h_{FE}$
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1275	V <sub>CBO</sub>	60	V
(Emitter open)	2SD1275A		80	
Collector-emitter voltage	2SD1275	V <sub>CEO</sub>	60	V
(Base open)	2SD1275A		80	
Emitter-base voltage (Coll	V <sub>EBO</sub>	5	V	
Collector current	I <sub>C</sub>	2	А	
Peak collector current		I <sub>CP</sub>	4	А
Collector power	$T_C = 25^{\circ}C$	P <sub>C</sub>	35	W
dissipation			2.0	
Junction temperature		Tj	150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C



#### Internal Connection



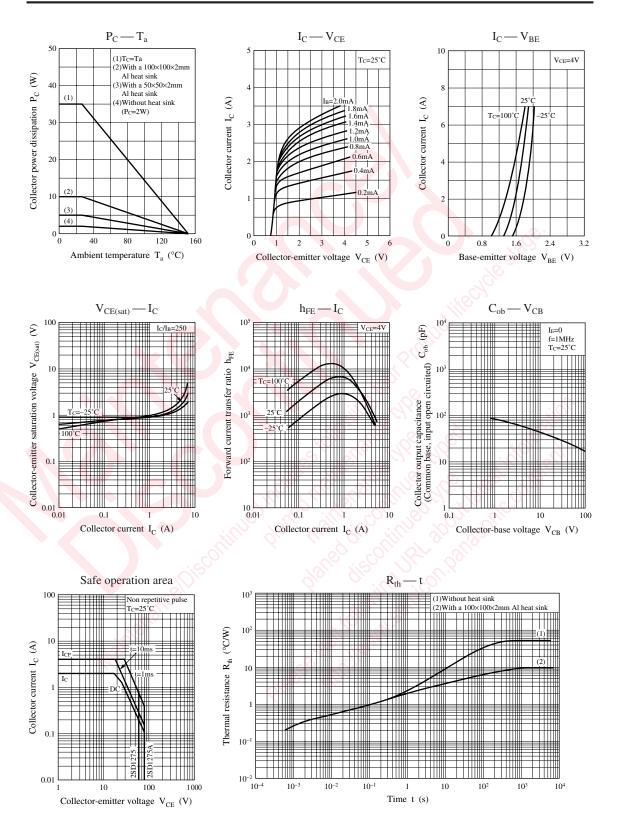
### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1275	V <sub>CEO</sub>	$I_{\rm C} = 30 \text{ mA}, I_{\rm B} = 0$	60	0° . C	<u>S</u>	V
(Base open)	2SD1275A	, e		80			
Base-emitter voltage		V <sub>BE</sub>	$V_{CE} = 4 V, I_C = 2 A$	8° , 2	5	2.8	V
Collector-base cutoff	2SD1275	I <sub>CBO</sub>	$V_{CB} = 60 \text{ V}, I_E = 0$	0		1	mA
current (Emitter open)	2SD1275A		$V_{CB} = 80 V, I_E = 0$	0.7		1	
Collector-emitter cutoff	2SD1275	I <sub>CEO</sub>	$V_{CE} = 30 \text{ V}, I_B = 0$			2	mA
current (Base open)	2SD1275A		$V_{CE} = 40 \text{ V}, I_B = 0$			2	
Emitter-base cutoff current (Col	lector open)	I <sub>EBO</sub>	$V_{EB} = 5 V, I_C = 0$			2	mA
Forward current transfer ratio		h <sub>FE1</sub>	$V_{CE} = 4 V, I_C = 1 A$	1 000			
		h <sub>FE2</sub> *	$V_{CE} = 4 V, I_C = 2 A$	1 0 0 0		10 000	
Collector-emitter saturation	voltage	V <sub>CE(sat)</sub>	$I_{C} = 2 A, I_{B} = 8 mA$			2.5	V
Transition frequency		f <sub>T</sub>	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 0.5 \text{ A}, \text{ f} = 1 \text{ MHz}$		20		MHz
Turn-on time		t <sub>on</sub>	$I_C = 2 A, I_{B1} = 8 mA, I_{B2} = -8 mA,$		0.5		μs
Storage time		t <sub>stg</sub>	$V_{CC} = 50 V$		4.0		μs
Fall time		t <sub>f</sub>			1.0		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Rank classification

Rank	R	Q	Р
h <sub>FE2</sub>	1 000 to 2 500	2000 to 5000	4000 to 10000

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